

VERIFICATION

The undersigned, of the below address, hereby certifies that he/she well knows both the English and Japanese languages, and that the attached is an accurate English translation of the U.S. Patent Application No. 10/755,848, filed on January 13, 2004 under priority of JP 2003-008744, filed January 16, 2003.

The undersigned declares further that all statements made herein of his/her own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Signed this 11th day of March, 2004.

Signature: Kazuki Iwatake

Address: Sumitomo Chemical Intellectual Property Service, Ltd.
5-33, Kitahama 4-Chome
Chuo-ku
Osaka 541-8550
JAPAN